

$V_{DSS}$	600V
$R_{DS(on)}$ (Max.)	0.102Ω
$I_D$	35A
$P_D$	120W

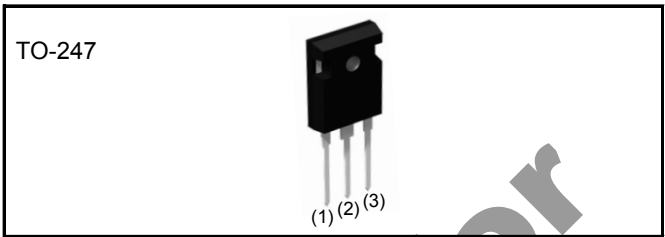
#### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage ( $V_{GSS}$ ) guaranteed to be  $\pm 20V$ .
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.
- 6) Pb-free lead plating ; RoHS compliant

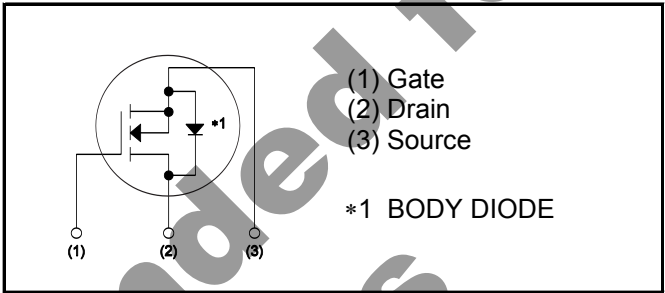
#### ●Application

Switching Power Supply

#### ●Outline



#### ●Inner circuit



#### ●Packaging specifications

Type	Packaging	Tube
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	450
	Taping code	C9
	Marking	R6035ENZ1

#### ●Absolute maximum ratings ( $T_a = 25^\circ C$ )

Parameter	Symbol	Value	Unit	
Drain - Source voltage	$V_{DSS}$	600	V	
Continuous drain current	$T_c = 25^\circ C$	$I_D^{*1}$	$\pm 35$	A
	$T_c = 100^\circ C$	$I_D^{*1}$	$\pm 19$	A
Pulsed drain current	$I_{D,pulse}^{*2}$	$\pm 105$	A	
Gate - Source voltage	$V_{GSS}$	$\pm 20$	V	
Avalanche energy, single pulse	$E_{AS}^{*3}$	796	mJ	
Avalanche energy, repetitive	$E_{AR}^{*3}$	1.2	mJ	
Avalanche current, repetitive	$I_{AR}$	6.6	A	
Power dissipation ( $T_c = 25^\circ C$ )	$P_D$	120	W	
Junction temperature	$T_j$	150	$^\circ C$	
Range of storage temperature	$T_{stg}$	-55 to +150	$^\circ C$	
Reverse diode dv/dt	dv/dt <sup>*4</sup>	15	V/ns	

### ●Absolute maximum ratings

Parameter	Symbol	Conditions	Values	Unit
Drain - Source voltage slope	dv/dt	$V_{DS} = 480V$ $T_j = 125^\circ C$	50	V/ns

### ●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	$R_{thJC}$	-	-	1.04	$^\circ C/W$
Thermal resistance, junction - ambient	$R_{thJA}$	-	-	30	$^\circ C/W$
Soldering temperature, wavesoldering for 10s	$T_{sold}$	-	-	265	$^\circ C$

### ●Electrical characteristics ( $T_a = 25^\circ C$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	600	-	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^\circ C$	-	0.1	100	$\mu A$
		$T_j = 125^\circ C$	-	-	1000	
Gate - Source leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V, I_D = 1mA$	2	-	4	V
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$V_{GS} = 10V, I_D = 18.1A$ $T_j = 25^\circ C$	-	0.092	0.102	$\Omega$
		$T_j = 125^\circ C$	-	0.200	-	
Gate input resistance	$R_G$	$f = 1MHz, \text{open drain}$	-	1.5	-	$\Omega$

**●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Transconductance	$g_{fs}^{*5}$	$V_{DS} = 10\text{V}, I_D = 17.5\text{A}$	11	22	-	S
Input capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$	-	2720	-	pF
Output capacitance	$C_{oss}$	$V_{DS} = 25\text{V}$	-	2000	-	
Reverse transfer capacitance	$C_{rss}$	$f = 1\text{MHz}$	-	240	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0\text{V}$ $V_{DS} = 0\text{V to } 480\text{V}$	-	100	-	pF
Effective output capacitance, time related	$C_{o(tr)}$		-	500	-	
Turn - on delay time	$t_{d(on)}^{*5}$	$V_{DD} \approx 300\text{V}, V_{GS} = 10\text{V}$ $I_D = 17.5\text{A}$ $R_L = 17.4\Omega$ $R_G = 10\Omega$	-	40	-	ns
Rise time	$t_r^{*5}$		-	80	-	
Turn - off delay time	$t_{d(off)}^{*5}$		-	210	-	
Fall time	$t_f^{*5}$		-	80	-	

**●Gate Charge characteristics ( $T_a = 25^\circ\text{C}$ )**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	$Q_g^{*5}$	$V_{DD} \approx 300\text{V}$	-	110	-	nC
Gate - Source charge	$Q_{gs}^{*5}$	$I_D = 35\text{A}$	-	15	-	
Gate - Drain charge	$Q_{gd}^{*5}$	$V_{GS} = 10\text{V}$	-	60	-	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} \approx 300\text{V}, I_D = 35\text{A}$	-	6.0	-	V

\*1 Limited only by maximum temperature allowed.

\*2  $P_W \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3  $I_D = 6.6\text{A}, V_{DD} = 50\text{V}$

\*4 Reference measurement circuits Fig.5-1.

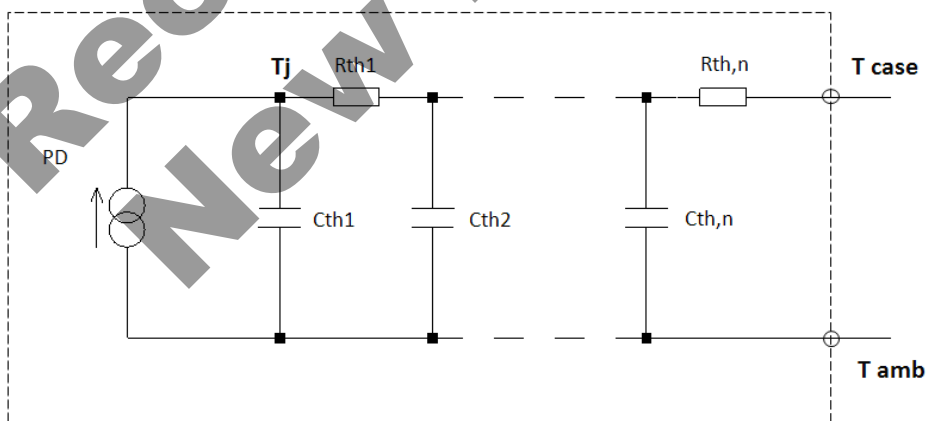
\*5 Pulsed

●Body diode electrical characteristics (Source-Drain) ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Inverse diode continuous, forward current	$I_S^{*1}$	$T_c = 25^\circ\text{C}$	-	-	35	A
Inverse diode direct current, pulsed	$I_{SM}^{*2}$		-	-	105	A
Forward voltage	$V_{SD}^{*5}$	$V_{GS} = 0\text{V}, I_S = 35\text{A}$	-	-	1.5	V
Reverse recovery time	$t_{rr}^{*5}$	$I_S = 35\text{A}$ $di/dt = 100\text{A}/\mu\text{s}$	-	780	-	ns
Reverse recovery charge	$Q_{rr}^{*5}$		-	16.5	-	$\mu\text{C}$
Peak reverse recovery current	$I_{rrm}^{*5}$		-	45	-	A

●Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
$R_{th1}$	0.151	K/W	$C_{th1}$	0.018	Ws/K
$R_{th2}$	0.428		$C_{th2}$	0.400	
$R_{th3}$	0.250		$C_{th3}$	15.4	



●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

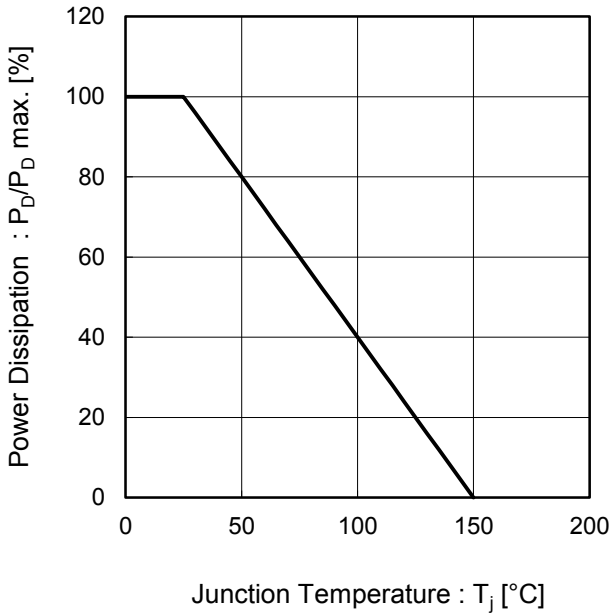


Fig.2 Normalized Transient Thermal Resistance vs. Pulse Width

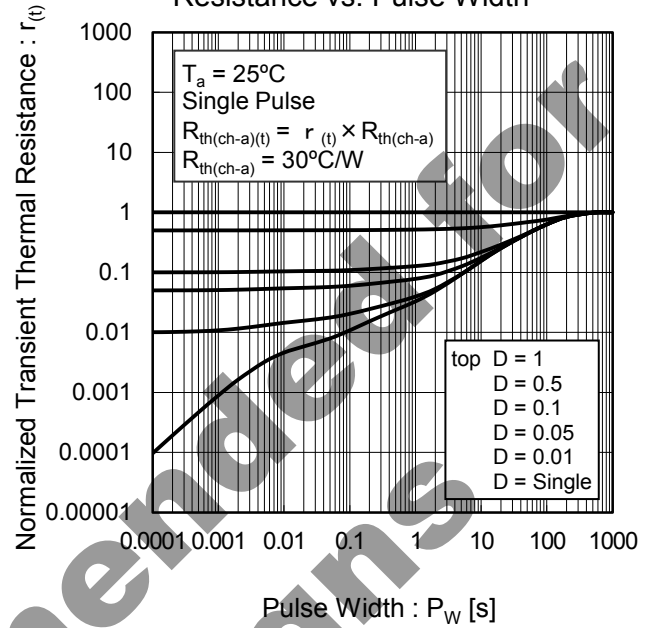
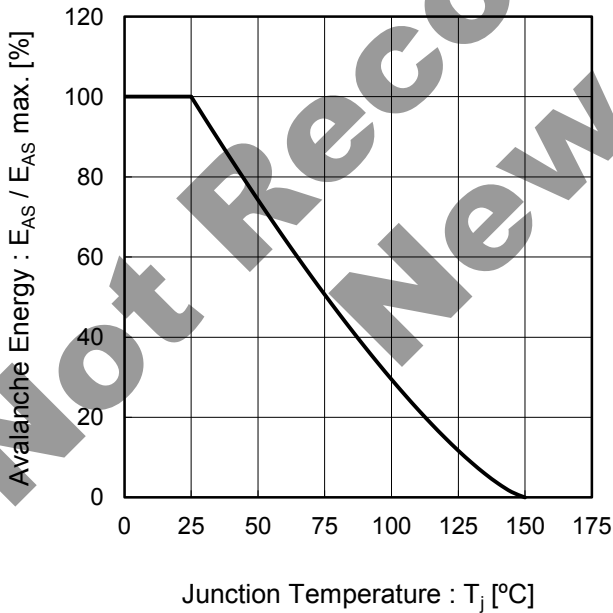


Fig.3 Avalanche Energy Derating Curve vs Junction Temperature



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

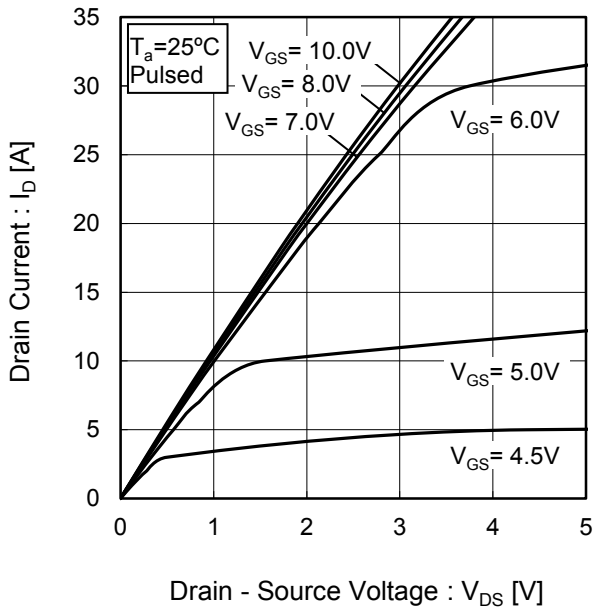


Fig.5 Typical Output Characteristics(II)

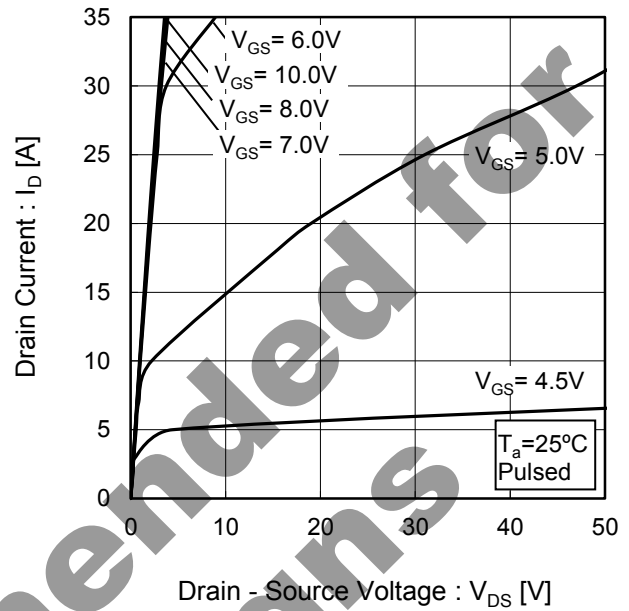


Fig.6  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(I)

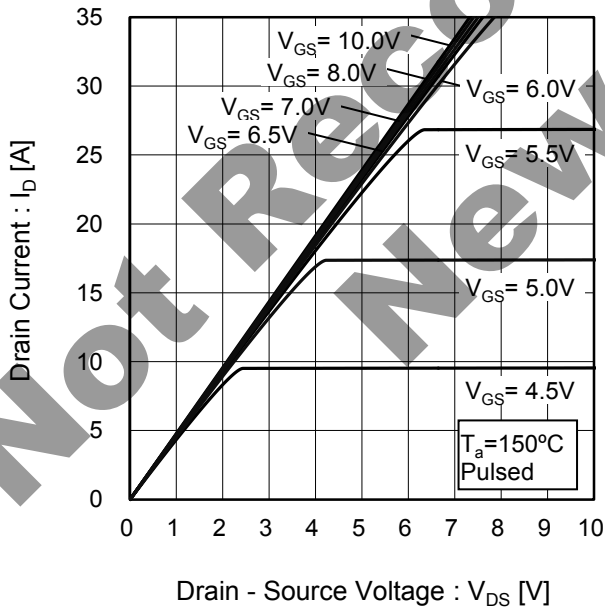
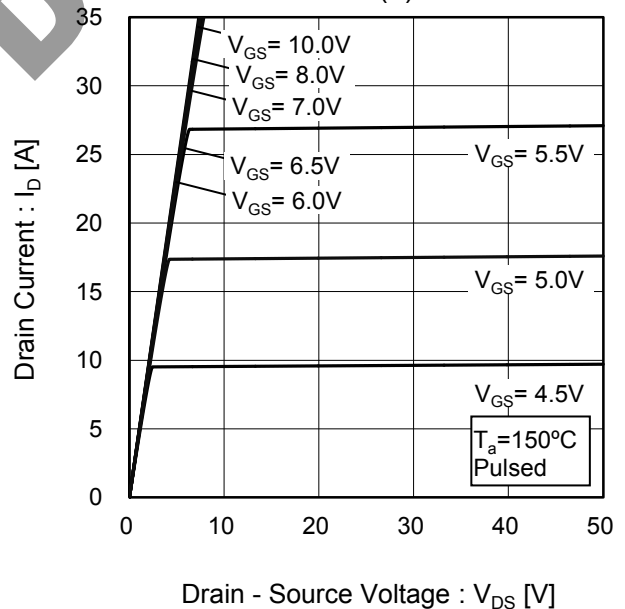


Fig.7  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.8 Breakdown Voltage vs. Junction Temperature

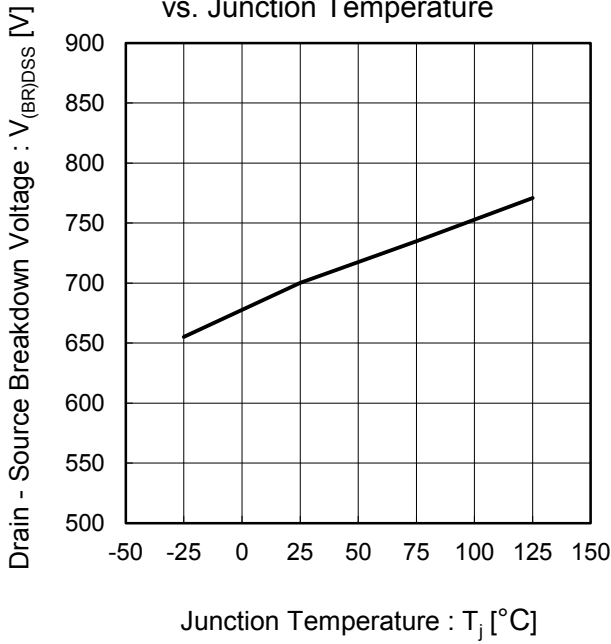


Fig.9 Typical Transfer Characteristics

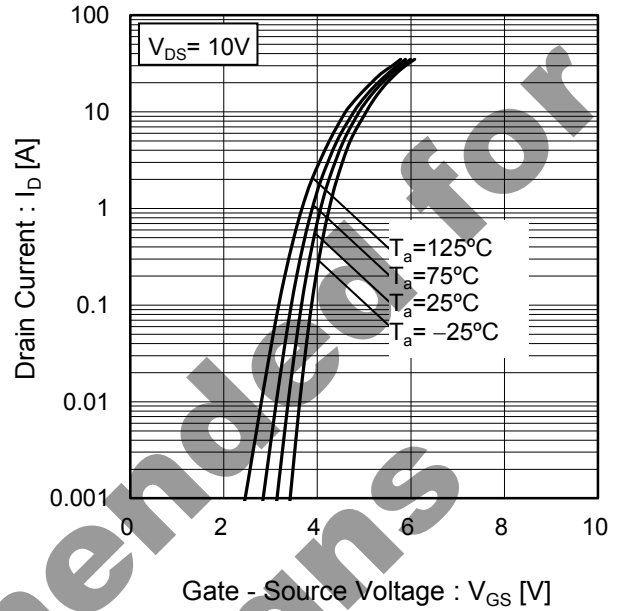


Fig.10 Gate Threshold Voltage vs. Junction Temperature

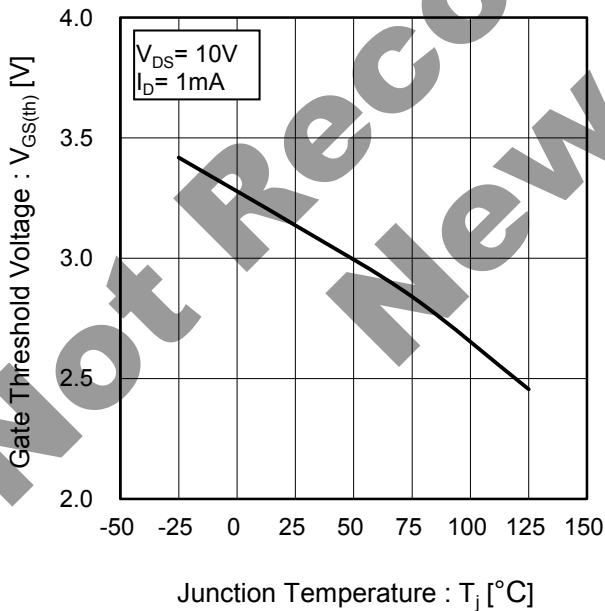
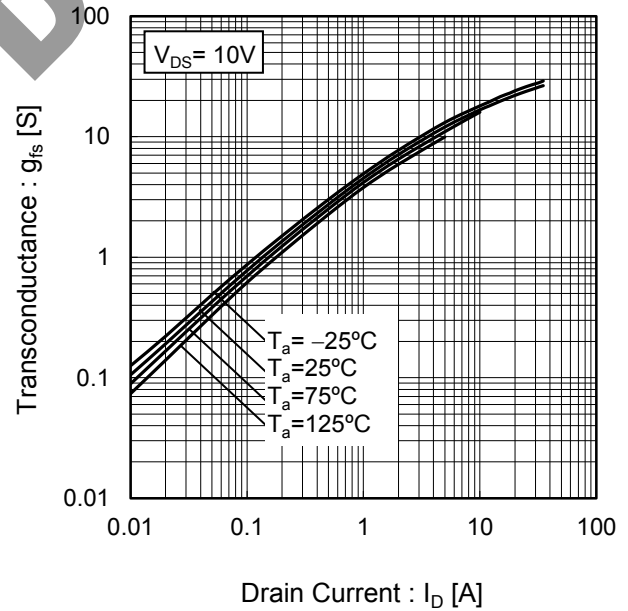


Fig.11 Transconductance vs. Drain Current



●Electrical characteristic curves

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

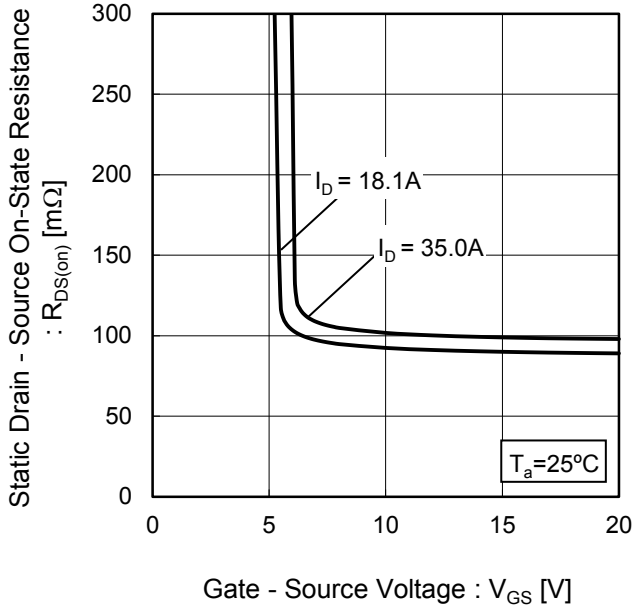


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

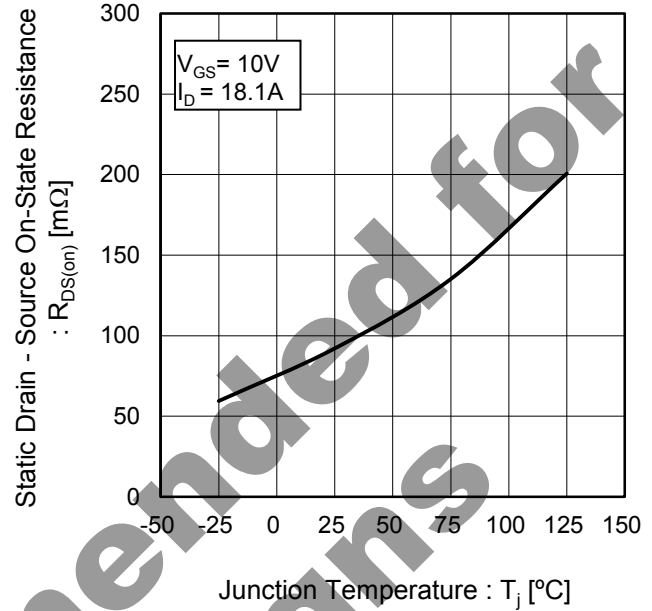


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current

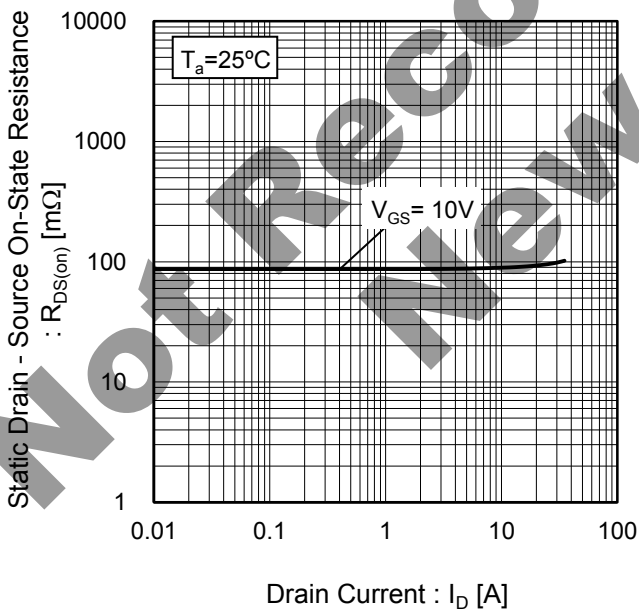
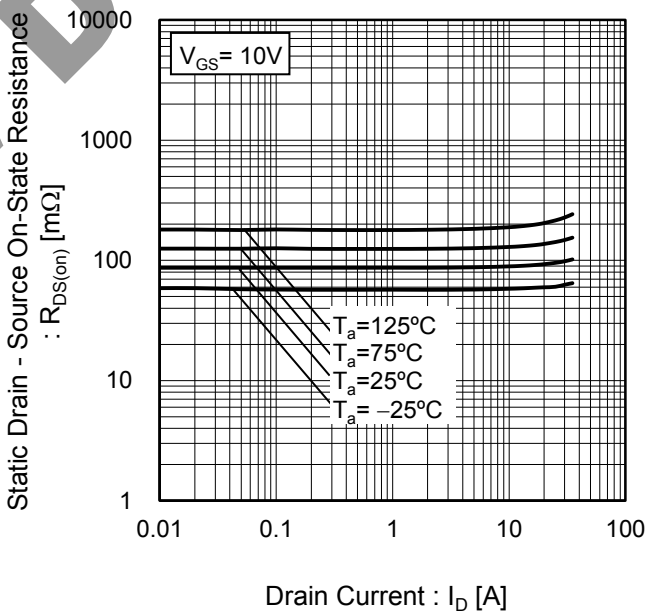


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current





●Electrical characteristic curves

Fig.16 Typical Capacitance vs. Drain - Source Voltage

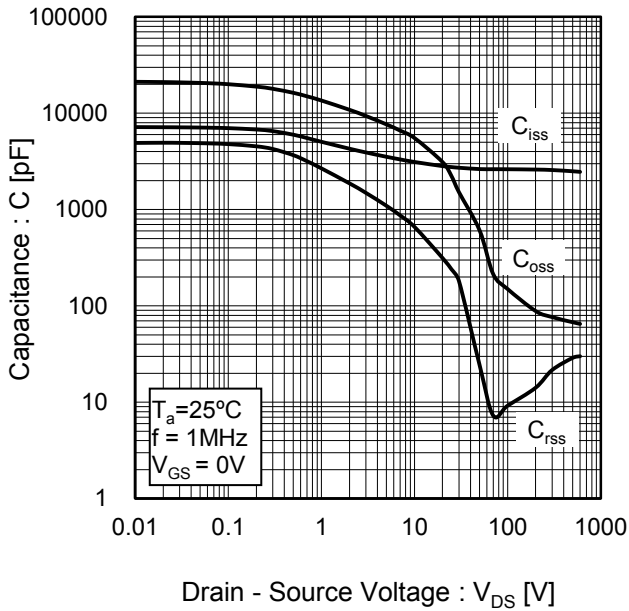


Fig.17 Coss Stored Energy

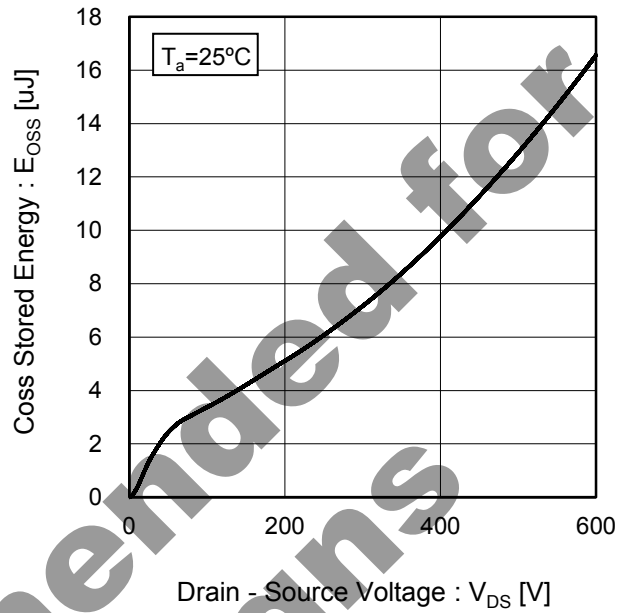


Fig.18 Switching Characteristics

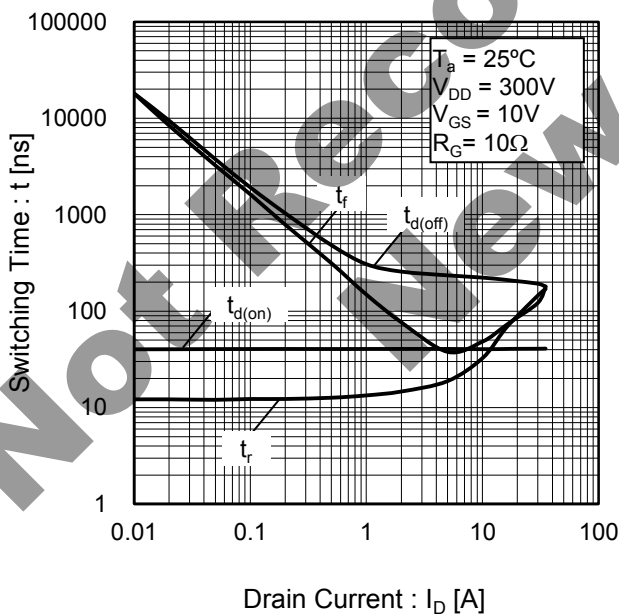
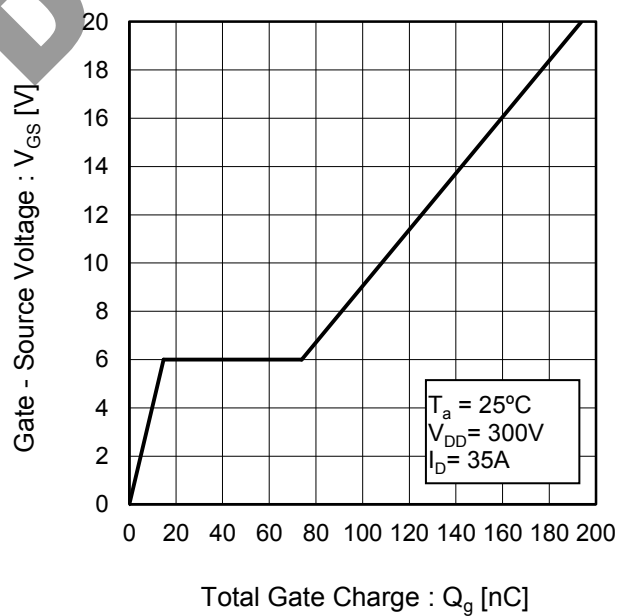


Fig.19 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.20 Inverse Diode Forward Current vs. Source - Drain Voltage

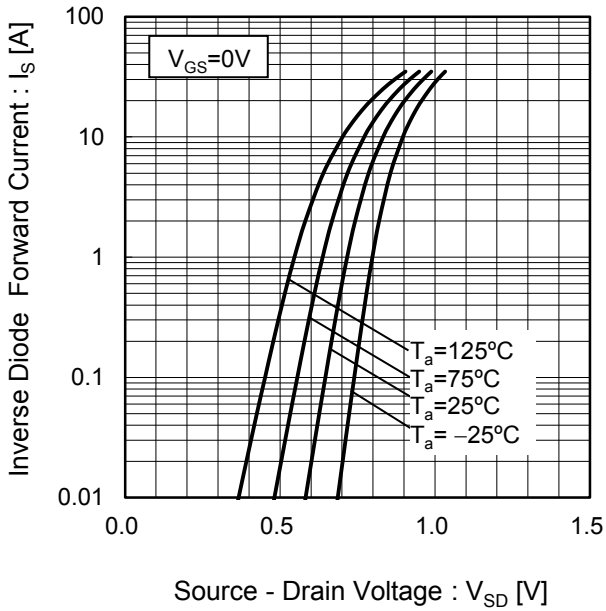
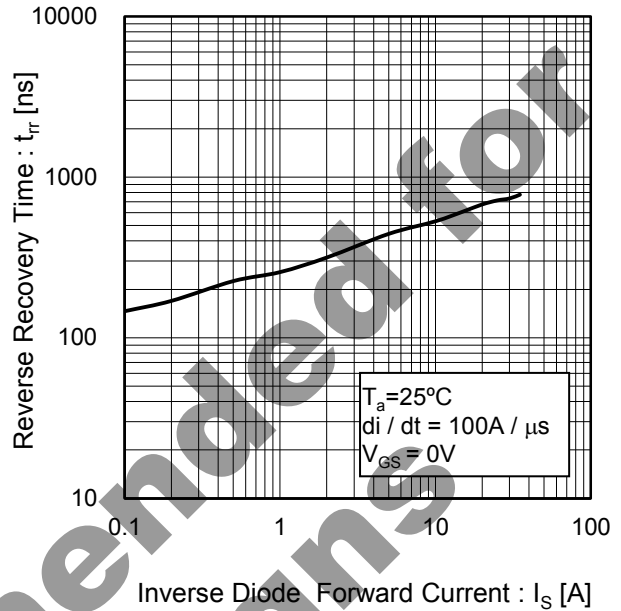


Fig.21 Reverse Recovery Time vs. Inverse Diode Forward Current



Not Recommended for New Design

● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

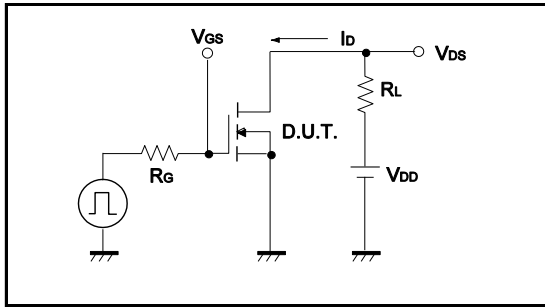


Fig.1-2 Switching Waveforms

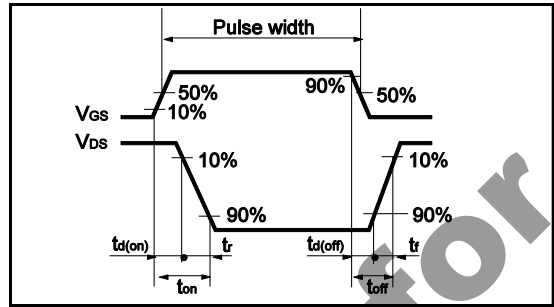


Fig.2-1 Gate Charge Measurement Circuit

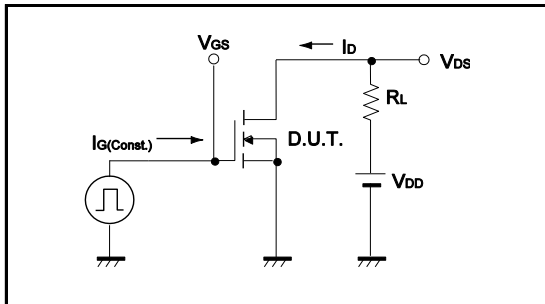


Fig.2-2 Gate Charge Waveform

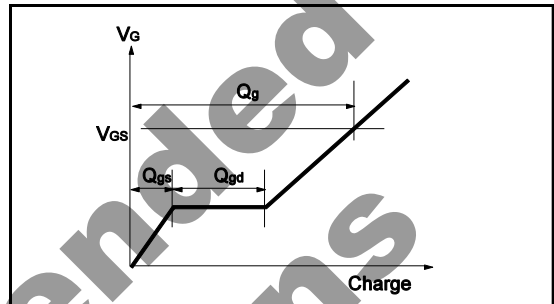


Fig.3-1 Avalanche Measurement Circuit

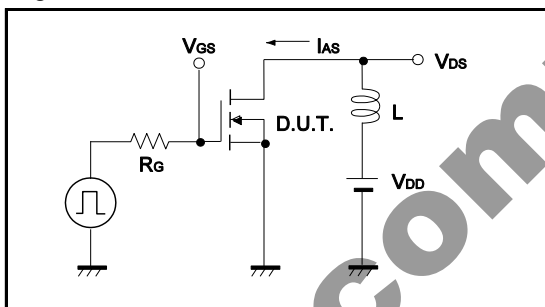


Fig.3-2 Avalanche Waveform

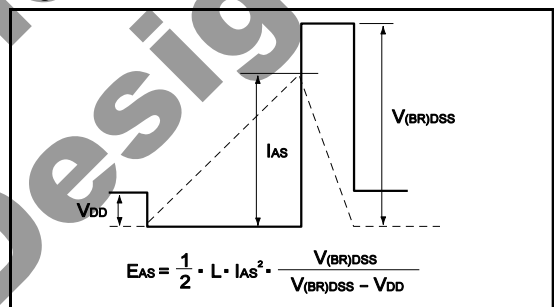


Fig.4-1 dv/dt Measurement Circuit

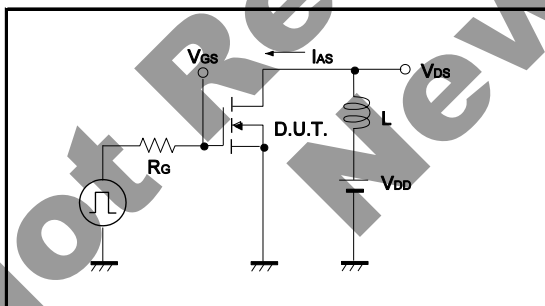


Fig.4-2 dv/dt Waveform

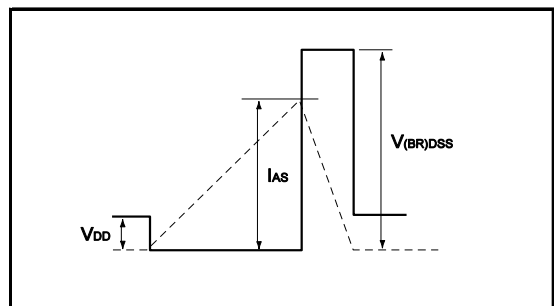


Fig.5-1 di/dt Measurement Circuit

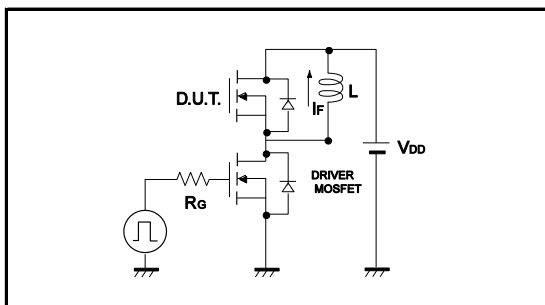
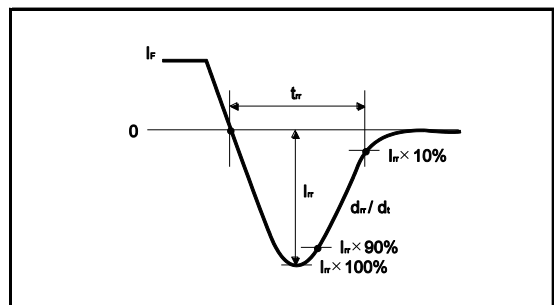
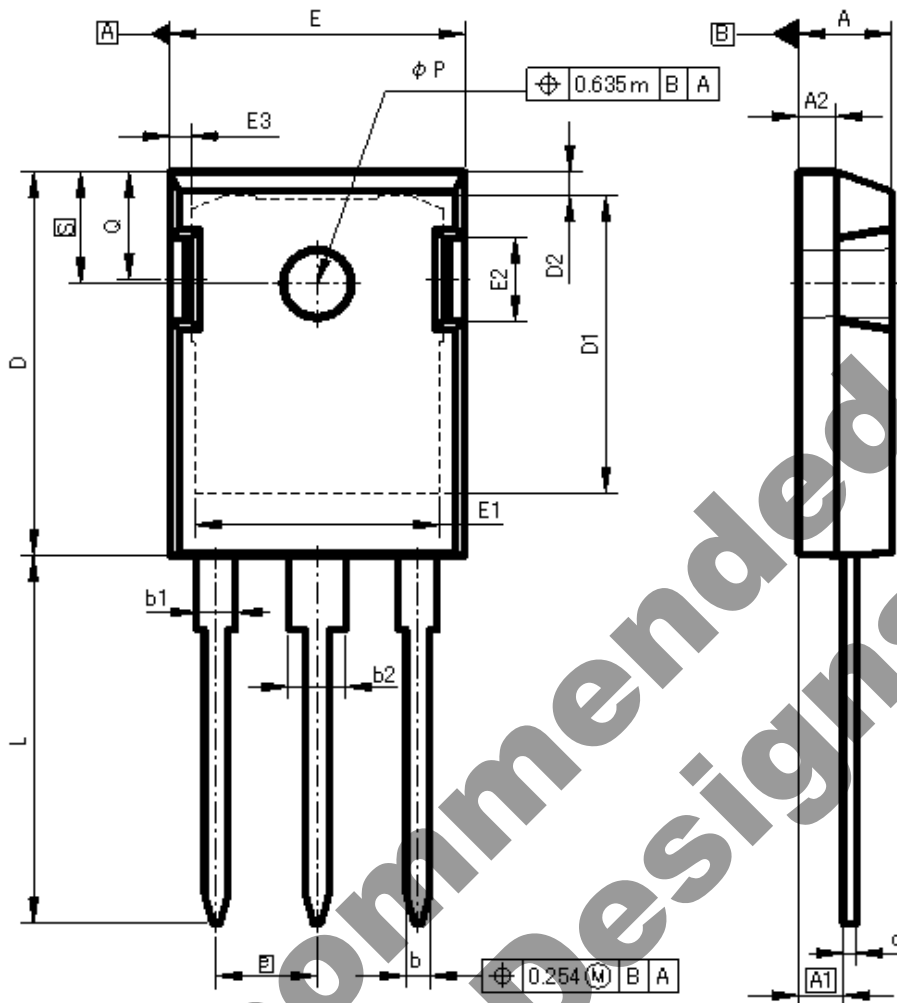


Fig.5-2 di/dt Waveform



●Dimensions (Unit : mm)

TO-247



DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.29	2.54	0.090	0.100
A2	1.91	2.16	0.075	0.085
b	1.14	1.40	0.045	0.055
b1	1.91	2.20	0.075	0.087
b2	2.92	3.20	0.115	0.126
c	0.61	0.80	0.024	0.031
D	20.80	21.34	0.819	0.840
D1	17.43	17.83	0.686	0.702
E	15.75	16.13	0.620	0.635
e	5.45		0.215	
N	3.00		3.000	
L	19.81	20.57	0.780	0.810
L1	3.81	4.32	0.150	0.170
ΦP	3.55	3.65	0.140	0.144
Q	5.59	6.20	0.220	0.244
S	6.15		0.240	

Dimension in mm / inches

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